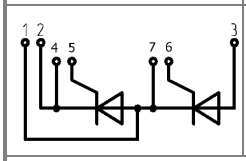
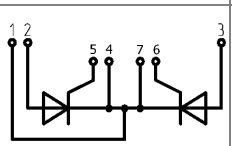
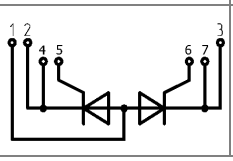
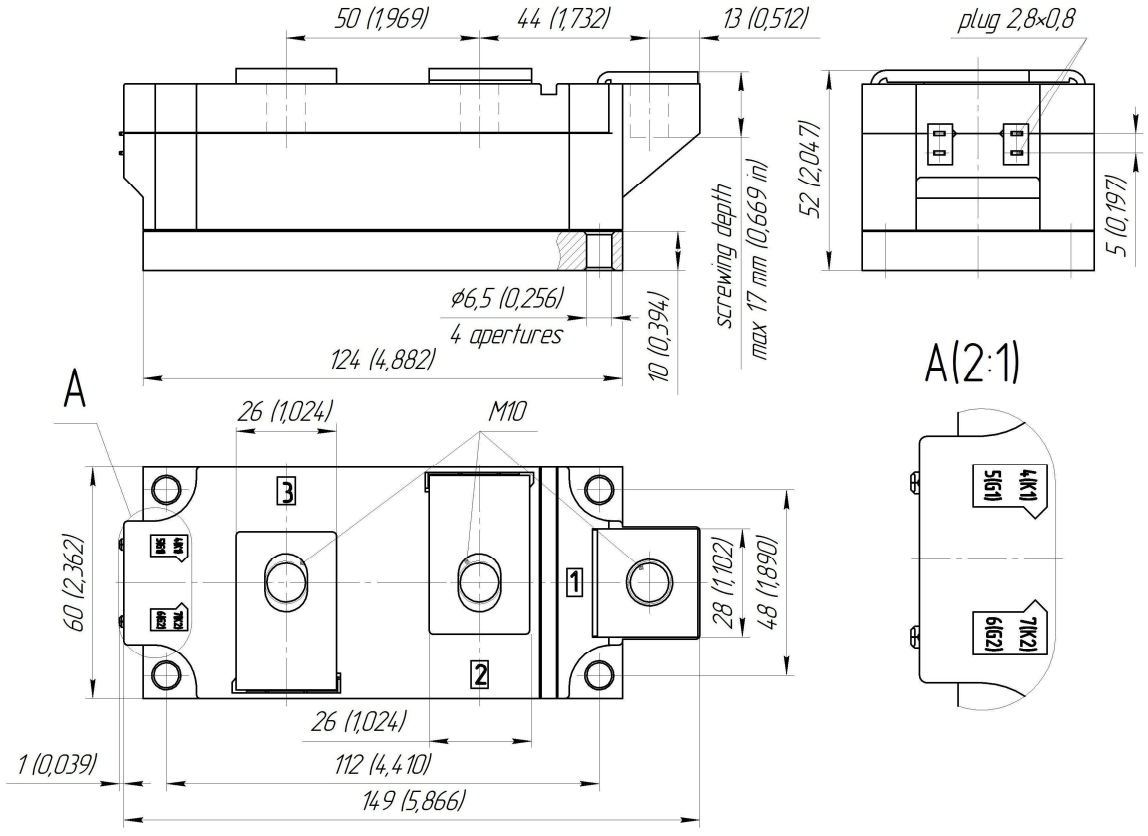
Electrically isolated base plate
Industrial standard package
Simplified mechanical design, rapid assembly
Pressure contact

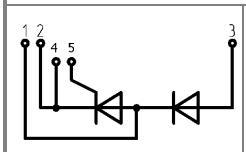
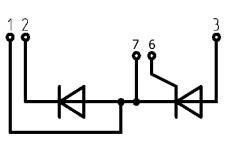
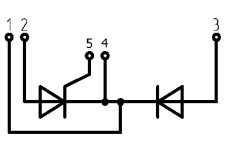
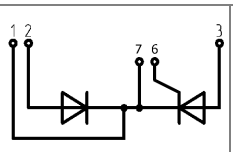
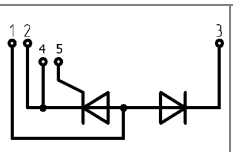
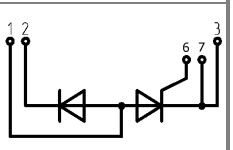
Double Thyristor Module For Phase Control MTx-320-36-A2

Mean on-state current		I_{TAV}	320 A	
Repetitive peak off-state voltage		V_{DRM}	3000 ÷ 3600 V	
Repetitive peak reverse voltage		V_{RRM}		
Turn-off time		t_q	320 µs	
V_{DRM}, V_{RRM}, V	3000	3200	3400	3600
Voltage code	30	32	34	36
T_j, °C	– 40 ÷ 125			

MT3 **MT4** **MT5**



MT/D3 **MD/T3** **MT/D4** **MD/T4** **MT/D5** **MD/T5**

All dimensions in millimeters (inches)

MAXIMUM ALLOWABLE RATINGS

Symbols and parameters		Units	Values	Test conditions	
ON-STATE					
I_{TAV}	Mean on-state current	A	320	T_c=85 °C; 180° half-sine wave; 50 Hz	
I_{TRMS}	RMS on-state current	A	502		
I_{TSM}	Surge on-state current	kA	5.5 6.0	T_j=$T_{j\,max}$ T_j=25 °C	180° half-sine wave; 50 Hz (t_p=10 ms); single pulse; V_D=V_R=0 V; Gate pulse: I_G=2 A; t_{GP}=50 μs; di_G/dt≥1 A/μs
			6.0 7.0	T_j=$T_{j\,max}$ T_j=25 °C	180° half-sine wave; 60 Hz (t_p=8.3 ms); single pulse; V_D=V_R=0 V; Gate pulse: I_G=2 A; t_{GP}=50 μs; di_G/dt≥1 A/μs
I^2t	Safety factor	$A^2s\cdot10^3$	150 180	T_j=$T_{j\,max}$ T_j=25 °C	180° half-sine wave; 50 Hz (t_p=10 ms); single pulse; V_D=V_R=0 V; Gate pulse: I_G=2 A; t_{GP}=50 μs; di_G/dt≥1 A/μs
			145 200	T_j=$T_{j\,max}$ T_j=25 °C	180° half-sine wave; 60 Hz (t_p=8.3 ms); single pulse; V_D=V_R=0 V; Gate pulse: I_G=2 A; t_{GP}=50 μs; di_G/dt≥1 A/μs
BLOCKING					
V_{DRM}, V_{RRM}	Repetitive peak off-state and Repetitive peak reverse voltages	V	3000÷3600	$T_{j\,min}$< T_j <$T_{j\,max}$; 180° half-sine wave; 50 Hz; Gate open	
V_{DSM}, V_{RSM}	Non-repetitive peak off-state and Non-repetitive peak reverse voltages	V	3100÷3700	$T_{j\,min}$< T_j <$T_{j\,max}$; 180° half-sine wave; 50 Hz;single pulse; Gate open	
V_D, V_R	Direct off-state and Direct reverse voltages	V	$0.75\cdot V_{DRM}$ $0.75\cdot V_{RRM}$	T_j=$T_{j\,max}$; Gate open	
TRIGGERING					
I_{FGM}	Peak forward gate current	A	8	T_j=$T_{j\,max}$	
V_{RGM}	Peak reverse gate voltage	V	5		
P_G	Gate power dissipation	W	4	T_j=$T_{j\,max}$ for DC gate current	
SWITCHING					
$(di_T/dt)_{crit}$	Critical rate of rise of on-state current non-repetitive (f=1 Hz)	A/μs	400	T_j=$T_{j\,max}$; V_D=$0.67\cdot V_{DRM}$; I_{TM}=2 I_{TAV}; Gate pulse: I_G=2 A; t_{GP}=50 μs; di_G/dt≥1 A/μs	
THERMAL					
T_{stg}	Storage temperature	°C	-40 ÷ 125		
T_j	Operating junction temperature	°C	-40 ÷ 125		
MECHANICAL					
a	Acceleration under vibration	m/s^2	50		

CHARACTERISTICS

Symbols and parameters		Units	Values	Conditions	
ON-STATE					
V_{TM}	Peak on-state voltage, max	V	2.20	T_j=25 °C; I_{TM}=785 A	
$V_{T(TO)}$	On-state threshold voltage, max	V	1.15	$T_j=T_{j\,max}$; $0.5\,\pi\,I_{TAV} < I_T < 1.5\,\pi\,I_{TAV}$	
r_T	On-state slope resistance, max	mΩ	0.800		
I_L	Latching current, max	mA	1000	T_j=25 °C; V_D=12 V; Gate pulse: I_G=2 A; t_{GP}=50 μs; $di_G/dt \geq 1$ A/μs	
I_H	Holding current, max	mA	300	T_j=25 °C; V_D=12 V; Gate open	
BLOCKING					
I_{DRM}, I_{RRM}	Repetitive peak off-state and Repetitive peak reverse currents, max	mA	200	$T_j=T_{j\,max}$; $V_D=V_{DRM}$; $V_R=V_{RRM}$	
$(dv_D/dt)_{crit}$	Critical rate of rise of off-state voltage, min	V/μs	1000	$T_j=T_{j\,max}$; $V_D=0.67 \cdot V_{DRM}$; Gate open	
TRIGGERING					
V_{GT}	Gate trigger direct voltage, max	V	4.00 2.50 2.00	$T_j=T_{j\,min}$ T_j=25 °C $T_j=T_{j\,max}$	V_D=12 V; I_D=3 A; Direct gate current
I_{GT}	Gate trigger direct current, max	mA	400 250 200	$T_j=T_{j\,min}$ T_j= 25 °C $T_j=T_{j\,max}$	
V_{GD}	Gate non-trigger direct voltage, min	V	0.35	$T_j=T_{j\,max}$; $V_D=0.67 \cdot V_{DRM}$; Direct gate current	
I_{GD}	Gate non-trigger direct current, min	mA	15.00		
SWITCHING					
t_{gd}	Delay time	μs	3.00	T_j=25 °C; $V_D=0.4 \cdot V_{DRM}$; $I_{TM}=I_{TAV}$; Gate pulse: I_G=2 A; t_{GP}=50 μs; $di_G/dt \geq 1$ A/μs	
t_q	Turn-off time, max	μs	320	dv_D/dt=50 V/μs; $T_j=T_{j\,max}$; $I_{TM}=I_{TAV}$; di_R/dt=10 A/μs; V_R=100V; V_D=0.67 V_{DRM};	
THERMAL					
R_{thjc}	Thermal resistance, junction to case				
	per module	°C/W	0.0340	180° half-sine wave, 50 Hz	
	per arm	°C/W	0.0680		
	per module	°C/W	0.0325	DC	
	per arm	°C/W	0.0650		
R_{thch}	Thermal resistance, case to heatsink				
	per module	°C/W	0.0100		
	per arm	°C/W	0.0200		
INSULATION					
V_{ISOL}	Insulation test voltage	kV	3.00	Sine wave, 50 Hz; RMS	t=1 min
			3.60		t=1 sec
MECHANICAL					
M_1	Mounting torque (M6)[1)]	Nm	6.00	Tolerance ± 15%	
M_2	Terminal connection torque (M10)[1)]	Nm	12.00	Tolerance ± 15%	
w	Weight	g	1500		

PART NUMBERING GUIDE

MT	3	-	320	-	36	-	A2	-	N
1	2		3		4		5		6

1. Thyristor module (MT)
   Thyristor – Diode module (MT/D)
   Diode – Thyristor module (MD/T)
2. Circuit Schematic:
   3 – serial connection
   4 – common Cathode
   5 – common Anode
3. Average On-state Current, A
4. Voltage Code
5. Package Type (M.A2)
6. Ambient Conditions:
   N – Normal

NOTES

[1)] The screws must be lubricated

UL certified file-No. E255404